

THERMAL PERFORMANCE						
PARAMETER	SYMBOL	TYP	UNIT			
Junction-to-lead thermal resistance	R <sub>OJL</sub>	13	°C/W			
Junction-to-ambient thermal resistance	R <sub>OJA</sub>	32	°C/W			
Junction-to-case thermal resistance	R <sub>eJC</sub>	8	°C/W			

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode <sup>(1)</sup>		I <sub>F</sub> = 2A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.0	V
		$I_F = 4A, T_J = 25^{\circ}C$		-	1.1	V
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>		T <sub>J</sub> = 25°C	I <sub>R</sub>	-	5	μA
		T <sub>J</sub> = 125°C		-	500	μΑ
Junction capacitance per diode	GBL005 GBL01 GBL02 GBL04	$1MHz, V_R = 4.0V$	С	95	-	pF
	GBL06 GBL08 GBL10			40	-	pF

## Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)(2)</sup>	PACKAGE	PACKING		
GBLx	GBL	25 / Tube		
GBLxH	GBL	25 / Tube		

## Notes:

- 1. "x" defines voltage from 50V(GBL005) to 1000V(GBL10)
- 2. "H" means AEC-Q101 qualified



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

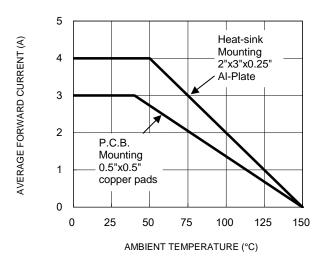


Fig.3 Typical Reverse Characteristics

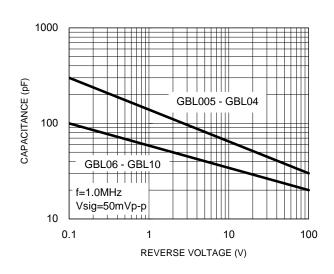
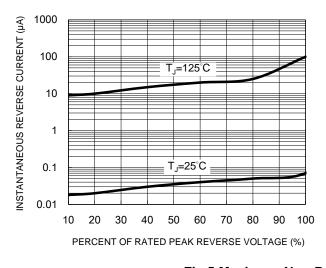


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



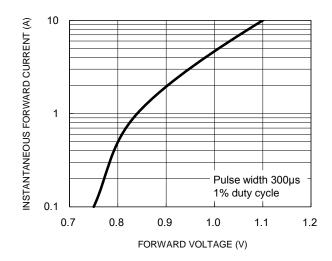


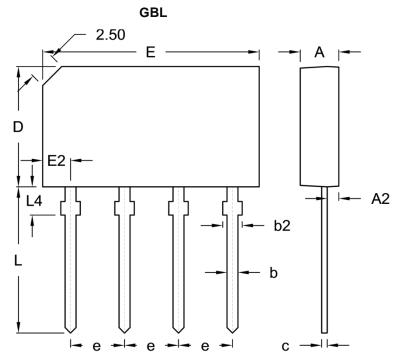
Fig.5 Maximum Non-Repetitive Forward Surge Current





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# **PACKAGE OUTLINE DIMENSIONS**



DIM.	Unit	Unit (mm)		Unit (inch)		
DIIVI.	Min.	Max.	Min.	Max.		
Α	3.30	3.70	0.130	0.146		
A2	0.80	1.20	0.031	0.047		
b	0.90	1.10	0.035	0.043		
b2	1.30	2.00	0.051	0.079		
С	0.40	0.60	0.016	0.024		
D	10.70	11.30	0.421	0.445		
E	19.70	20.30	0.776	0.799		
E2	2.30	2.70	0.091	0.106		
е	4.80	5.20	0.189	0.205		
L	13.00	14.00	0.512	0.551		
L4	2.30	2.70	0.091	0.106		

## **MARKING DIAGRAM**



P/N = Marking Code

G = Green Compound

YWW = Date Code

F = Factory Code





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GBL04 GBL06 GBL08 GBL10 GBL10H